Energy dependence of defect energy levels in electron irradiated silicon

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1. Introduction. — Most of the simple point defects produced by electron irradiation in silicon have been identified and their electronic properties determined using conventional techniques (such as electron paramagnetic resonance and optical absorption) [1]. Recently the recombination parameters of some of these defects have been studied using capacitive methods, such as thermally stimulated capacitance (TSCAP) and deep level transient spectroscopy (DLTS) [2, 3]. In silicon only one study [4] deals with defects introduced by electron irradiation at low temperature, i.e. primary defects (vacancies and divacancies), the other studies [5-13] deal with defects introduced by irradiation at room temperature, i.e. defects which are stable at 300 K (divacancy, A and E centers, etc.). The identification of the defects detected by a capacitive method is made by comparing the energy levels and the annealing temperatures measured with the values found for the defects which have been identified using conventional techniques. Such a way of identifying defects is not without problems because the energy levels and the annealing temperatures determined with conventional techniques are sometimes known with a low accuracy; in addition they can vary with the nature and/or the concentration of the doping impurity, the dose of irradiation, etc. Moreover, a confusion is possible for defects exhibiting similar energy levels.

The aim of this paper is to study, using capacitive techniques, the energy dependence of the defect levels introduced by room temperature electron irradiation in order to distinguish between vacancy — and divacancy — type defects and so verify in a direct way the identifications which have been made concerning the divacancy and some of the vacancy associated defects. Vacancy type defects and divacancies correspond to different threshold energies for atomic displacement and consequently to different variations.
of their creation rates (number of defects introduced by one incident electron) versus the energy of irradiation. According to Watkins and Corbett [14] the threshold energies for vacancy and divacancy formation are respectively 25 and 50 eV. We shall describe in this paper results obtained using TSCAP and verified through capacitance spectroscopy (DLTS). The samples studied are diodes used as high voltage power rectifiers. The technological aim of the study was to investigate the conditions required to replace gold impurities by electron induced defects in order to produce fast switching rectifiers.

2. Experimental. — The diodes are p⁺-n structures made by aluminium diffusion in 130 Ω cm phosphorus doped FZ material. The electrical contacts are made by n⁺ (phosphorus) and p⁺ (gallium) diffusions.

The irradiations are performed with a Van de Graaff machine equipped to produce 150 keV to 3 MeV electrons. The electron beam is scanned so that the sample is homogeneously irradiated. The intensity of the beam is of the order of 0.1 μA cm⁻² in order to insure that the temperature of the samples never exceeds 50 °C during the irradiation. The sample is placed in a Faraday cup and the current integrated to account for possible fluctuations of the beam intensity.

Capacitive measurements are performed with the diode placed in a liquid nitrogen cryostat equipped with a temperature stabilization which allows linear variations of temperature with time (from ~ 4 K min⁻¹ up to ~ 80 K min⁻¹) from 80 K to 330 K.

For transient capacitance measurements a standard Booton (model 72 A operating at 1 MHz) capacitance bridge is used. The bias pulses are applied through the bridge which introduces a time constant of ~ 1 ms. The transient signal is analysed with the use of two box-cars and the emission rates measured are corrected [15], when necessary, to account for the time constant of the capacitance meter.

3. Experimental results. — Prior to irradiation the analysis of the capacitance-voltage C(V) characteristics reveals a constant profile of majority carrier, with a concentration 3.5 x 10¹³ cm⁻³ at 77 K.

As shown in figure 1, the TSCAP curves C(T) exhibits after irradiation three stages, centered at about 100 K (stage 1), 135 K (stage 2) and 170 K (stage 3). The signal observed by transient spectroscopy is given in figure 2 before and after an annealing at 190 °C for 250 min. The positions of the different levels observed have been measured. They are :

\[ E₁ = 0.18 \text{ eV}, \quad E_{II} = 0.23 \text{ eV}, \quad E_{III} = 0.32 \text{ eV}, \]
\[ E_{IV} = 0.39 \text{ eV} \quad \text{and} \quad E_V = 0.43 \text{ eV} \]

from the conduction band.

Transient TSCAP measurements at various temperatures T, around the temperatures of the stages, provide the emission rate \( e_n \) of electrons from the (acceptor) centers, from which the position of the associated level in the gap is deduced (from the plot of \( \ln(e_n/T^2) \) versus \( T^{-1} \)). It is found that stages 1 and 2 correspond respectively to \( E_{II} \) and \( E_{III} \). Stage 3 is the sum of \( E_{IV} \) and \( E_V \); this can be seen when a 190 °C annealing is performed, which induced the recovery of \( E_V \) (see Fig. 2).

The level \( E_1 \) is not directly observed with TSCAP measurements : it occurs at a temperature lower than 80 K and only induces an increase with temperature of the base line of the TSCAP curve.

The cross-sections for electron trapping on these levels have been estimated from DLTS measurements through the extrapolation of the curve \( \ln(\tau_{max} T^2) \)
Table 1. — *Energy levels and cross-sections for electron trapping for the different levels observed.*

<table>
<thead>
<tr>
<th>Level</th>
<th>Energy (eV)</th>
<th>Cross-section ( \times 10^{-15} ) (cm(^{-2}))</th>
</tr>
</thead>
<tbody>
<tr>
<td>( E_{\text{II}} )</td>
<td>0.23</td>
<td>3</td>
</tr>
<tr>
<td>( E_{\text{III}} )</td>
<td>0.33</td>
<td>0.9</td>
</tr>
<tr>
<td>( E_{\text{IV}} )</td>
<td>0.39</td>
<td>2</td>
</tr>
<tr>
<td>( E_{\text{V}} )</td>
<td>0.43</td>
<td>7</td>
</tr>
</tbody>
</table>

versus \( T^{-1} \) for \( T = \infty (\tau_{\text{max}} \text{ is the rate window}) \). They are given in table I.

The variation of the defect introduction rate (number of defect per incident electron) has been measured for the defects corresponding to the three TSCAP stages. The results are given in figure 3.

Fig. 3. — Defect introduction rates for the three stages versus the energy of irradiation (\( \square \) stage 1; \( \bullet \) stage 2; \( \Delta \) stage 3). The full lines correspond to the theoretical variations for vacancy type defects (25 eV) and divacancy type defects (50 eV).

4. Discussion. — The defects introduced by electron irradiation in n-type silicon have been studied by Evwaraye [6-8, 10] and Kimerling [3] and the levels we observed have been also reported by these authors. Some of the levels were attributed to identified defects whose energy level positions were known: \( E_{\text{I}} \) to the vacancy-oxygen (A) center [5-12], \( E_{\text{II}} \) and \( E_{\text{IV}} \) to the divacancy [5-9, 11, 12], \( E_{\text{V}} \) to the phosphorus-vacancy pair (E center) [13]. The \( E_{\text{III}} \) level, also observed by Evwaraye [9], has not yet been identified. The values of the cross-sections for electron trapping we evaluated are in reasonable agreement with the values reported in the literature. They are within a factor of two equal to the values published for \( E_{\text{III}} \) [9], \( E_{\text{IV}} \) [13] and \( E_{\text{V}} \) [7]; our value found for \( E_{\text{II}} \) is similar to the one published in reference [9] but a factor of 10 too high as compared to the values published in references [7] and [13].

As shown in figure 3, the defect creation rate (concentration of defect in the stage divided by the electron dose) \( \tau_{3} \) of stage 3 seems to follow the theoretical curve [16] corresponding to a threshold energy of 25 eV for low energies (lower than 1 MeV); this is consistent with the fact that it is associated with \( V-P \) pairs (the divacancy concentration is negligible for these energies, but not for higher energies). Also, in the low energy range, the defect creation rate \( \tau_{1} \) of stage 1 seems to follow the theoretical curve for 50 eV; this is consistent with the fact that this stage is ascribed to the divacancy. The accuracy of the measurement of the defect introduction rate \( \tau_{2} \) of stage 2 was even lower than for stages 3 and 1 and it cannot apparently be ascribed to any of the two theoretical curves. This low accuracy is due to the fact that it is difficult to compare quantitatively capacity changes between different diodes. In order to avoid this difficulty we plot in figure 4 the ratios \( \tau_{2}/\tau_{1} \) and \( \tau_{3}/\tau_{1} \), versus the energy of irradiation, for the same diode. We observe in this case that these ratios are clearly in agreement with the theoretical curve giving the ratio between vacancies and divacancies creation rates.

We can therefore conclude that stages 2 and 3 correspond to a threshold of 25 eV and stage 1 to a threshold of 50 eV.

5. Conclusion. — The results we present here are in good agreement with the results reported by Evwaraye. The energy dependence of the defect creation...
rates for the three defects we studied provide a direct confirmation of the identification which was previously proposed: the 0.23 eV is associated with the divacancy and the 0.43 eV with the phosphorus-vacancy pair. In addition we demonstrate that the 0.32 eV is associated with a vacancy-type defect.

References